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<sup>@2014</sup> Fairchild Semiconductor Corporation

FGB3040G2\_F085 / FGD3040G2\_F085 / FGP3040G2\_F085 Rev.C3

Devie	ce Marking	Device	Package F	Reel Size	Tape Widt	h Quantity		tity
FG	B3040G2	FGB3040G2_F085	TO-263AB	330mm	24mm		80	0
FG	D3040G2	FGD3040G2_F085	TO-252AA	330mm	16mm		250	0
FG	P3040G2	FGP3040G2_F085	TO-220AB	Tube	N/A		50	)
Electr Symbol		racteristics T <sub>A</sub> = 25° Parameter	C unless otherwise not		Min	Тур	Max	Unit
Cymbo		1 diameter	1631 001	lations		IJP	Max	Unit
Off Sta	te Charact	eristics						
BV <sub>CER</sub>	Collector to E	Emitter Breakdown Voltage	$I_{CE} = 2mA, V_{GE} = 0,$ $R_{GE} = 1K\Omega,$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$		370	400	430	v
BV <sub>CES</sub>	Collector to E	Emitter Breakdown Voltage	$I_{CE} = 10mA, V_{GE} = 0V$ $R_{GE} = 0,$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$	,	390	420	450	v
BV <sub>ECS</sub>	Emitter to Co	ollector Breakdown Voltage	I <sub>CE</sub> = -20mA, V <sub>GE</sub> = 0\ T <sub>J</sub> = 25°C	Ι,	28	-	-	V
BV <sub>GES</sub>	Gate to Emit	ter Breakdown Voltage	I <sub>GES</sub> = ±2mA		±12	±14	-	V
	Collector to F	Emitter Leakage Current	V <sub>CE</sub> = 250V, R <sub>GE</sub> = 1k			-	25	μA
CER				T <sub>J</sub> = 150 <sup>o</sup>		-	1	mA
ECS	Emitter to Co	ollector Leakage Current	V <sub>EC</sub> = 24V,	$T_J = 25^{\circ}C$ $T_J = 150^{\circ}C$		-	1 40	mA
R₁	Series Gate	Resistance		1 100	-	120	-	Ω
	Gate to Emit	ter Resistance			10K	-	30K	Ω
$R_2$					I		1	
	te Charact	eristics						
			I <sub>CE</sub> = 6A, V <sub>GE</sub> = 4V,	T <sub>J</sub> = 25°0	c -	1.15	1.25	V

3040G2_F
=085 / FG
D3040G2_
F085 / FGF
3040G2_
F085

FGB

# **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance Junction to Case	-	-	1

 $V_{CE(SAT)}$  Collector to Emitter Saturation Voltage  $I_{CE}$  = 15A,  $V_{GE}$  = 4.5V,

Self Clamped Inductive Switching

## Notes:

E<sub>SCIS</sub>

1: Self Clamping Inductive Switching Energy ( $E_{SCIS25}$ ) of 300 mJ is based on the test conditions that starting Tj=25°C; L=3mHy, I<sub>SCIS</sub>=14.2A,V<sub>CC</sub>=100V during inductor charging and V<sub>CC</sub>=0V during the time in clamp.

 $L = 3.0 \text{ mHy}, RG = 1K\Omega$ ,

VGE = 5V, (Note 1)

 $T_{.1} = 150^{\circ}C$ 

TJ = 25°C

-

1.68

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1.85

300

V

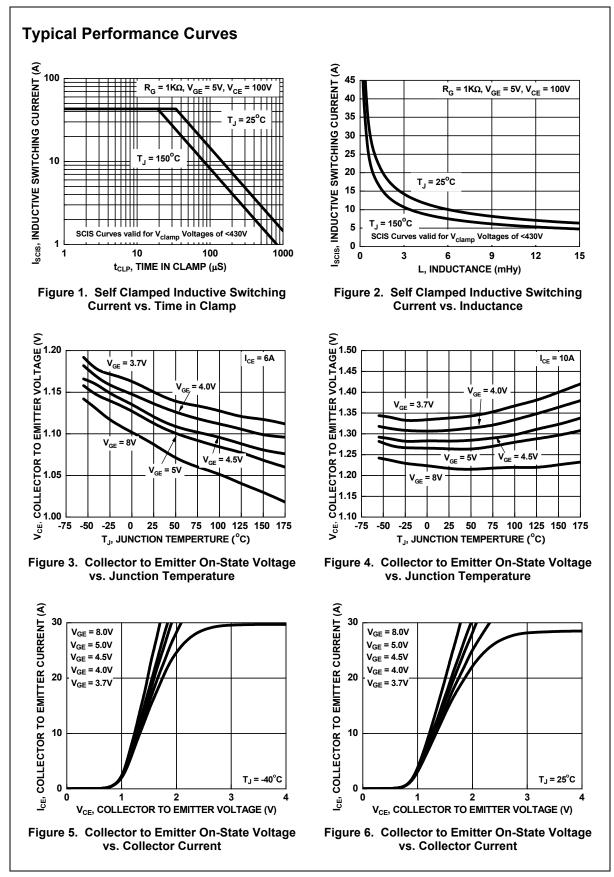
mJ

°C/W

2: Self Clamping Inductive Switching Energy ( $E_{SCIS150}$ ) of 170 mJ is based on the test conditions that starting Tj=150°C; L=3mHy, I<sub>SCIS</sub>=10.8A,V<sub>CC</sub>=100V during inductor charging and V<sub>CC</sub>=0V during the time in clamp.

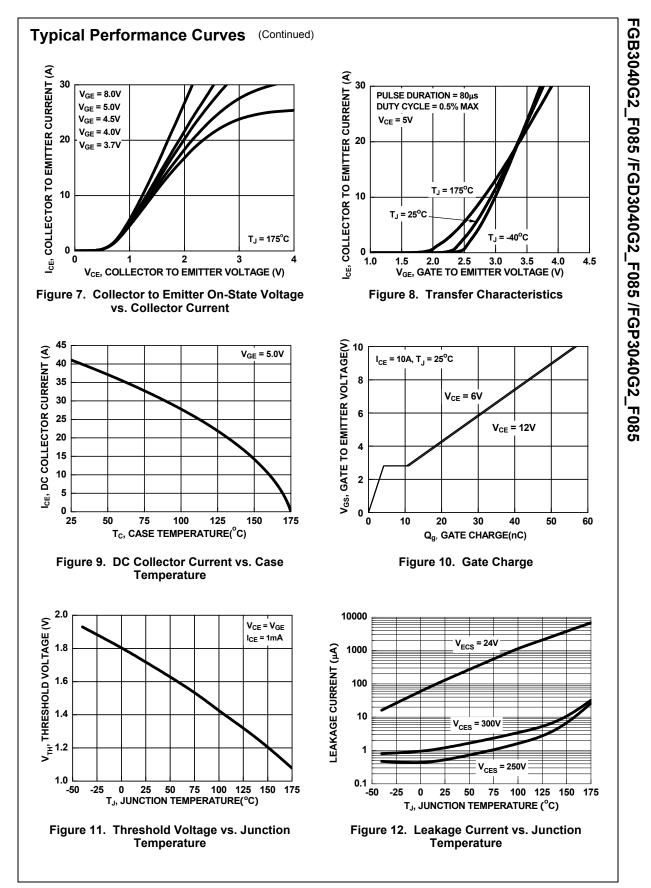


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$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$U_{G(ON)}$ Gate Charge $V_{GE} = 5V$ $ 21$ $ 11C$ $V_{GE(TH)}$ Gate to Emitter Threshold Voltage $I_{CE} = 1mA, V_{CE} = V_{GE}$ $T_J = 25^{\circ}C$ $1.3$ $1.7$ $2.2$ $V$ $V_{GEP}$ Gate to Emitter Plateau Voltage $V_{CE} = 12V, I_{CE} = 10A$ $ 2.8$ $ V$ Switching Characteristics $g_{(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ $ 0.9$ $4$ $\mu s$ $v_{GE}$ Current Rise Time-Resistive $V_{CE} = 5V, R_G = 1K\Omega$ $ 1.9$ $7$ $\mu s$ $g_{(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ $ 4.8$ $15$ $\mu s$ $v_{GE} = 5V, R_G = 1K\Omega$ $V_{GE} = 5V, R_G = 1K\Omega$ $ 4.8$ $15$ $\mu s$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Dynam	ic Characteristics						
$V_{GE(TH)}$ Gate to Emitter Threshold Voltage $I_{CE} = 1MA, V_{CE} = V_{GE},$ $T_J = 150^{\circ}C$ $0.75$ $1.2$ $1.8$ $V$ $V_{GEP}$ Gate to Emitter Plateau Voltage $V_{CE} = 12V, I_{CE} = 10A$ $ 2.8$ $ V$ Switching Characteristics $C_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ $ 0.9$ $4$ $\mu s$ $C_{TR}$ Current Rise Time-Resistive $V_{CE} = 5V, R_G = 1K\Omega$ $ 1.9$ $7$ $\mu s$ $C_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ $ 4.8$ $15$ $\mu s$ $V_{GE} = 5V, R_G = 1K\Omega$ $V_{GE} = 5V, R_G = 1K\Omega$ $ 4.8$ $15$ $\mu s$	VGE(TH)Gate to Emitter Threshold Voltage $I_{CE} = 1MA, V_{CE} = V_{GE},$ $T_J = 150^{\circ}C$ $0.75$ $1.2$ $1.8$ VVGEPGate to Emitter Plateau Voltage $V_{CE} = 12V, I_{CE} = 10A$ - $2.8$ -VSwitching Characteristics $t_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ - $0.9$ $4$ $\mu s$ $t_{rR}$ Current Rise Time-Resistive $V_{CE} = 5V, R_G = 1K\Omega$ - $1.9$ $7$ $\mu s$ $t_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ - $4.8$ $15$ $\mu s$ $V_{GE} = 5V, R_G = 1K\Omega$ $V_{GE} = 5V, R_G = 1K\Omega$ - $4.8$ $15$ $\mu s$	$V_{GE(TH)}$ Gate to Emitter Threshold Voltage $I_{CE} = 1MA, V_{CE} = V_{GE},$ $T_J = 150^{\circ}C$ $0.75$ $1.2$ $1.8$ $V_{CE}$ $V_{GEP}$ Gate to Emitter Plateau Voltage $V_{CE} = 12V, I_{CE} = 10A$ $ 2.8$ $ V$ wwitching Characteristics $g(ON)_R$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ $ 0.9$ $4$ $\mu s$ $R$ Current Rise Time-Resistive $V_{CE} = 5V, R_G = 1K\Omega$ $ 1.9$ $7$ $\mu s$ $g(OFF)_L$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ $ 4.8$ $15$ $\mu s$ VGE = 5V, $R_G = 1K\Omega$ $ 4.8$ $15$ $\mu s$	VGE(TH)Gate to Emitter Threshold Voltage $I_{CE} = 1mA$ , $V_{CE} = V_{GE}$ , $T_J = 150^{\circ}C$ $T_J = 150^{\circ}C$ $0.75$ $1.2$ $1.8$ $V$ VGEPGate to Emitter Plateau Voltage $V_{CE} = 12V$ , $I_{CE} = 10A$ $ 2.8$ $ V$ Switching Characteristicstd_{(ON)R}Current Turn-On Delay Time-Resistive $V_{CE} = 14V$ , $R_L = 1\Omega$ $ 0.9$ $4$ $\mu s$ $V_{TR}$ Current Rise Time-Resistive $V_{CE} = 5V$ , $R_G = 1K\Omega$ $ 1.9$ $7$ $\mu s$ $t_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V$ , $L = 1mH$ , $V_{GE} = 5V$ , $R_G = 1K\Omega$ $ 4.8$ $15$ $\mu s$ $V_{GE} = 5V$ , $R_G = 1K\Omega$ $ 4.8$ $15$ $\mu s$	Q <sub>G(ON)</sub>	Gate Charge			-	21	-	nC
$V_{GEP}$ Gate to Emitter Plateau Voltage $V_{CE} = 12V$ , $I_{CE} = 10A$ -2.8-VSwitching Characteristics $G_{(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V$ , $R_L = 1\Omega$ -0.94 $\mu s$ $G_{(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 5V$ , $R_G = 1K\Omega$ -1.97 $\mu s$ $T_{T} = 25^{\circ}C$ , $T_{J} = 25^{\circ}C$ ,-1.97 $\mu s$ $G_{(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V$ , $L = 1mH$ ,-4.815 $\mu s$ $V_{GE} = 5V$ , $R_G = 1K\Omega$ $V_{GE} = 5V$ , $R_G = 1K\Omega$ -2.015 $\mu s$	$V_{GEP}$ Gate to Emitter Plateau Voltage $V_{CE} = 12V$ , $I_{CE} = 10A$ -2.8-VSwitching Characteristics $I_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V$ , $R_L = 1\Omega$ -0.94 $\mu s$ $I_{rR}$ Current Rise Time-Resistive $V_{GE} = 5V$ , $R_G = 1K\Omega$ -1.97 $\mu s$ $I_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V$ , $L = 1mH$ ,-4.815 $\mu s$ $V_{GE} = 5V$ , $R_G = 1K\Omega$ $V_{GE} = 5V$ , $R_G = 1K\Omega$ -4.815 $\mu s$	$V_{GEP}$ Gate to Emitter Plateau Voltage $V_{CE} = 12V$ , $I_{CE} = 10A$ -2.8-VSwitching Characteristics $d_{(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V$ , $R_L = 1\Omega$ -0.94 $\mu s$ $R_R$ Current Rise Time-Resistive $V_{GE} = 5V$ , $R_G = 1K\Omega$ -1.97 $\mu s$ $d_{(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V$ , $L = 1mH$ ,-4.815 $\mu s$ $G_{(OFF)L}$ Current Foll Time-Inductive $V_{GE} = 5V$ , $R_G = 1K\Omega$ -4.815 $\mu s$	$V_{GEP}$ Gate to Emitter Plateau Voltage $V_{CE} = 12V$ , $I_{CE} = 10A$ -2.8-VSwitching Characteristics $I_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V$ , $R_L = 1\Omega$ -0.94 $\mu s$ $I_{rR}$ Current Rise Time-Resistive $V_{CE} = 5V$ , $R_G = 1K\Omega$ -1.97 $\mu s$ $I_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V$ , $L = 1mH$ ,-4.815 $\mu s$ $V_{GE} = 5V$ , $R_G = 1K\Omega$ $V_{GE} = 5V$ , $R_G = 1K\Omega$ -4.815 $\mu s$	√ <sub>GE(TH)</sub>	Gate to Emitter Threshold Voltage	$I_{CE}$ = 1mA, $V_{CE}$ = $V_{GE}$ ,					V
$C_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -0.94 $\mu s$ $T_{R}$ Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -1.97 $\mu s$ $T_J = 25^{\circ}C,$ $T_J = 25^{\circ}C,$ -1.97 $\mu s$ $C_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -4.815 $\mu s$ $V_{GE} = 5V, R_G = 1K\Omega$ $V_{GE} = 5V, R_G = 1K\Omega$ -1.97 $\mu s$	$t_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -0.94 $\mu s$ $t_{rR}$ Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -1.97 $\mu s$ $t_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -4.815 $\mu s$ $t_{d(OFF)L}$ Current Foll Time Inductive $V_{GE} = 5V, R_G = 1K\Omega$ -4.815 $\mu s$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$t_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -0.94 $\mu s$ $V_{TR}$ Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -1.97 $\mu s$ $t_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -4.815 $\mu s$ $V_{GE} = 5V, R_G = 1K\Omega$ $V_{GE} = 5V, R_G = 1K\Omega$ -2.015 $\mu s$	√ <sub>GEP</sub>	Gate to Emitter Plateau Voltage	V <sub>CE</sub> = 12V, I <sub>CE</sub> = 10A	Ū			-	V
$C_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -0.94 $\mu s$ $T_{R}$ Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -1.97 $\mu s$ $T_J = 25^{\circ}C,$ $T_J = 25^{\circ}C,$ -1.97 $\mu s$ $C_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -4.815 $\mu s$ $V_{GE} = 5V, R_G = 1K\Omega$ $V_{GE} = 5V, R_G = 1K\Omega$ -1.97 $\mu s$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Switchi	ing Characteristics						
$\frac{V_{GE} = 5V, R_G = 1K\Omega}{T_J = 25^{\circ}C,} - \frac{1.9}{7} \mu s$ $\frac{V_{GE} = 5V, R_G = 1K\Omega}{T_J = 25^{\circ}C,} - \frac{1.9}{7} \mu s$ $\frac{V_{GE} = 300V, L = 1mH,}{V_{GE} = 5V, R_G = 1K\Omega} - \frac{4.8}{15} \mu s$	$\frac{V_{GE} = 5V, R_G = 1K\Omega}{T_J = 25^{\circ}C,} - \frac{1.9}{7} \mu s$ $\frac{V_{GE} = 5V, R_G = 1K\Omega}{T_J = 25^{\circ}C,} - \frac{1.9}{7} \mu s$ $\frac{V_{GE} = 300V, L = 1mH,}{V_{GE} = 5V, R_G = 1K\Omega} - \frac{4.8}{15} \mu s$	$\begin{array}{c c} R & Current Rise Time-Resistive \\ \hline H_{G}(OFF)L \\ \hline Current Turn-Off Delay Time-Inductive \\ \hline H_{G}(OFF)L \\ \hline Current Foll Time Inductive \\ \hline V_{GE} = 5V, R_{G} = 1K\Omega \\ \hline \end{array}$	$\begin{array}{c c} & Current Rise Time-Resistive \\ \hline G_{I_{1}} = 25^{\circ}C, \\ \hline G_{I_{2}} = 25^{\circ}C, \\ \hline G_{I_{2}} = 25^{\circ}C, \\ \hline G_{I_{2}} = 300V, L = 1mH, \\ \hline G_{I_{2}} = 5V, R_{G} = 1K\Omega \\ \hline G_{I_{2}} = 1K\Omega \\ \hline G$					-	0.9	4	μS
$\frac{V_{G(OFF)L}}{V_{GE}} = \frac{V_{CE}}{1000} = \frac{1000}{1000} = \frac$	$\frac{V_{G(OFF)L}}{V_{GE}} = \frac{V_{CE}}{1000} = \frac{1000}{1000} = \frac$	$\frac{1}{D(OFF)L}  Current Turn-Off Delay Time-Inductive}{\Gamma_{CE} = 300V, L = 1mH,} \qquad - 4.8  15  \mu s$	$\frac{V_{CE} = 300V, L = 1mH,}{V_{CE} = 5V, R_G = 1K\Omega}$		Current Rise Time-Resistive	$V_{GE} = 5V, R_G = 1K\Omega$ T <sub>1</sub> = 25°C		-	1.9	7	μS
$V_{GE} = 5V, R_G = 1K\Omega$	$V_{GE} = 5V, R_G = 1K\Omega$	$V_{GE} = 5V, R_G = 1K\Omega$	$V_{GE} = 5V, R_G = 1K\Omega$	d(OFF)L	Current Turn-Off Delay Time-Inductive	V <sub>CE</sub> = 300V, L = 1mH,		-	4.8	15	μS
ICE = 0.04, IJ = 20 0,				fL	Current Fall Time-Inductive	$V_{GE} = 5V, R_G = 1K\Omega$		-	2.0	15	μS



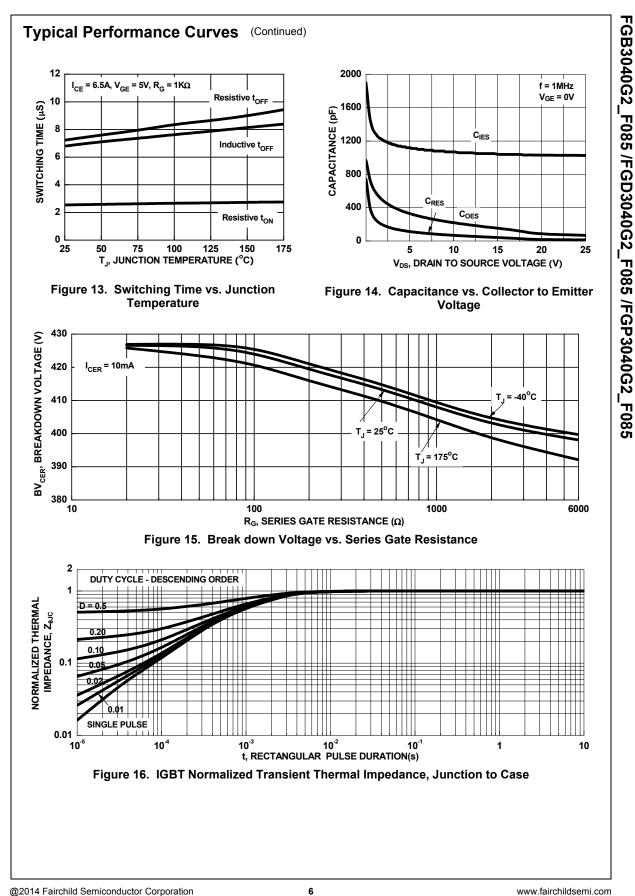
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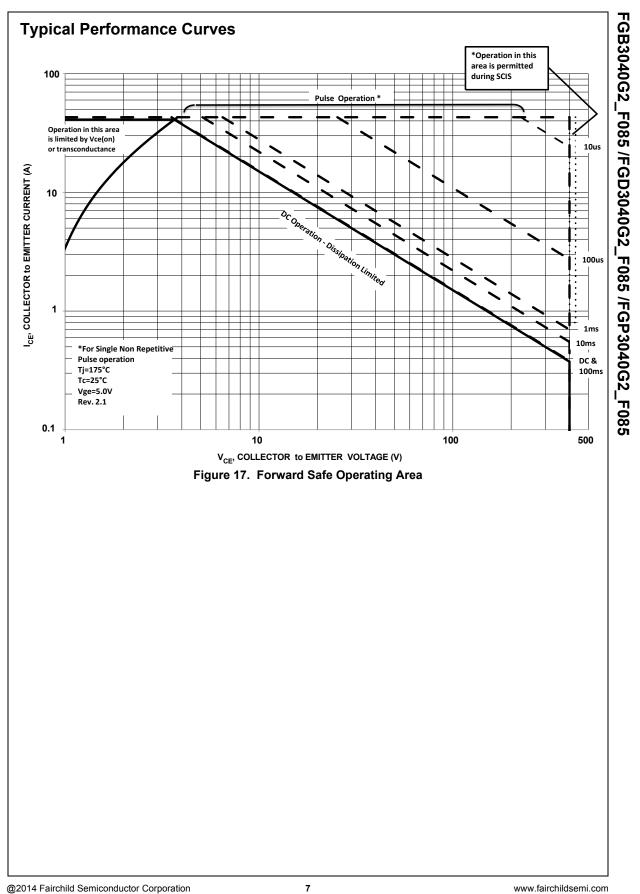


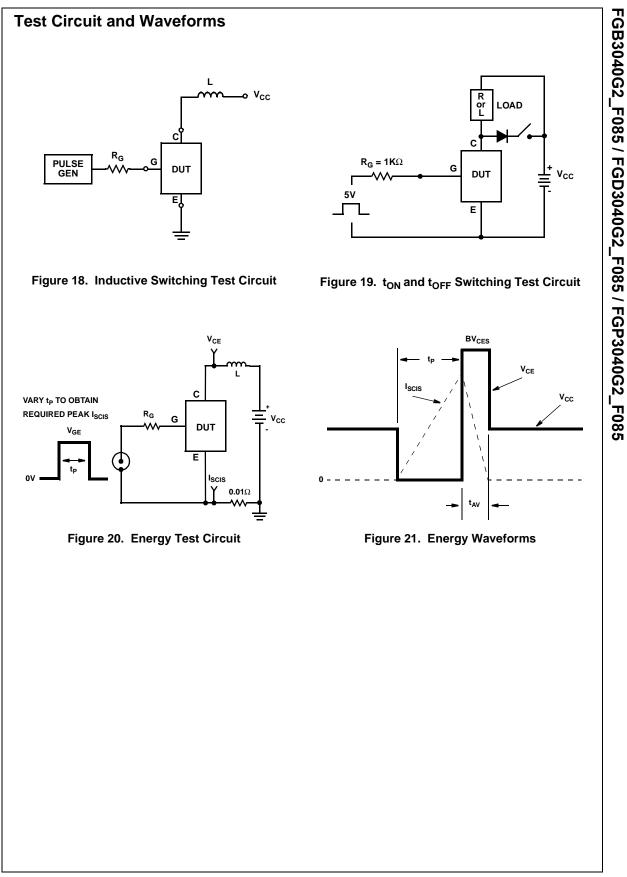
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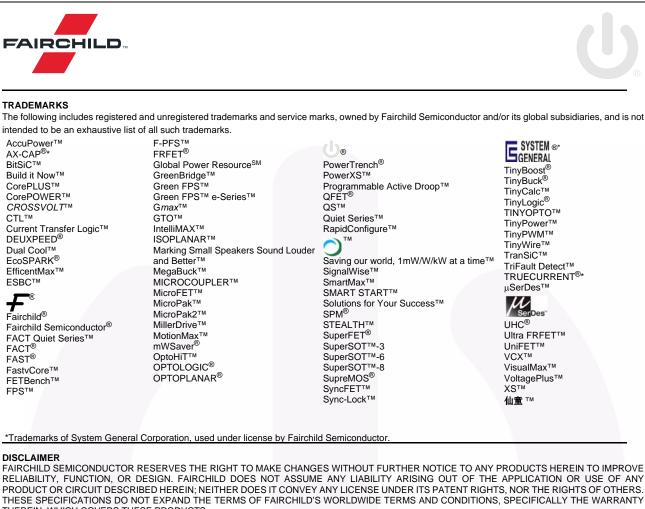


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